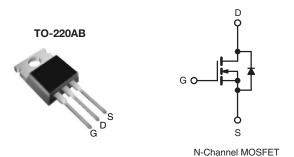


Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|----------------------------|--|--|--|--|
| V _{DS} (V) | 600 | | | | |
| R _{DS(on)} (Ω) | V _{GS} = 10 V 1.2 | | | | |
| Q _g (Max.) (nC) | 42 | | | | |
| Q _{gs} (nC) | 10 | | | | |
| Q _{gd} (nC) | 20 | | | | |
| Configuration | Single | | | | |



FEATURES

• Low Gate Charge Qq Results in Simple Drive



 Improved Gate, Avalanche and Dynamic dV/dt RoHS Ruggedness

- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

• Single Transistor Forward

| ORDERING INFORMATION | |
|----------------------|--------------|
| Package | TO-220AB |
| Lead (Pb)-free | IRFBC40APbF |
| | SiHFBC40A-E3 |
| SnPb | IRFBC40A |
| | SiHFBC40A |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwi | | | SYMBOL | LIMIT | UNIT |
|---|-----------------------------------|---|------------------|------------------|----------|
| Drain-Source Voltage | | | V _{DS} | 600 | V |
| Gate-Source Voltage | | | V _{GS} | ± 30 | |
| Continuous Duois Current | V -140V | T _C = 25 °C | - I _D | 6.2 | |
| Continuous Drain Current | V _{GS} at 10 V | $T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$ | | 3.9 | А |
| Pulsed Drain Current ^a | | | I _{DM} | 25 | |
| Linear Derating Factor | | | | 1.0 | W/°C |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 570 | mJ |
| Repetitive Avalanche Currenta | | | I _{AR} | 6.2 | А |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 13 | mJ |
| Maximum Power Dissipation $T_C = 25 ^{\circ}C$ | | | P _D | 125 | W |
| Peak Diode Recovery dV/dtc | dV/dt | 6.0 | V/ns | | |
| Operating Junction and Storage Temperature Rang | T _J , T _{stg} | - 55 to + 150 | 20 | | |
| Soldering Recommendations (Peak Temperature) for 10 s | | | | 300 ^d | °C |
| Manustina Tanana | 6-32 or M3 screw | | | 10 | lbf ⋅ in |
| Mounting Torque | | | | 1.1 | N · m |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Starting T_J = 25 °C, L = 29.6 mH, R_q = 25 Ω , I_{AS} = 6.2 A (see fig. 12).
- c. $I_{SD} \le 6.2$ A, $dI/dt \le 80$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFBC40A, SiHFBC40A

Vishay Siliconix



| THERMAL RESISTANCE RATINGS | | | | | | |
|-------------------------------------|-------------------|------|------|------|--|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | | | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.50 | - | °C/W | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | = | 1.0 | | | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|---|---|------|------|-------|------------------|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 600 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 0.66 | - | V/°C |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | V _{DS} : | = V _{GS} , I _D = 250 μA | 2.0 | - | 4.0 | ٧ |
| Gate-Source Leakage | I _{GSS} | | V _{GS} = ± 30 V | - | - | ± 100 | nA |
| Zoro Coto Voltago Droin Current | | V _{DS} = | V _{DS} = 600 V, V _{GS} = 0 V | | - | 25 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 480 \ | /, V _{GS} = 0 V, T _J = 125 °C | - | - | 250 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | I _D = 3.7 A ^b | - | - | 1.2 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} | = 50 V, I _D = 3.7 A | 3.4 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 1036 | - | |
| Output Capacitance | Coss | | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5 | | 136 | - | - - - - |
| Reverse Transfer Capacitance | C _{rss} | f = 1 | | | 7.0 | - | |
| Output Capacitance | C _{oss} | V _{GS} = 0 V | V _{DS} = 1.0 V, f = 1.0 MHz | - | 1487 | - | pF |
| | | | V _{DS} = 480 V, f = 1.0 MHz | - | 36 | - | |
| Effective Output Capacitance | C _{oss} eff. | | V _{DS} = 0 V to 480 V ^c | | 48 | - | 1 |
| Total Gate Charge | Qg | | V _{GS} = 10 V I _D = 6.2 A, V _{DS} = 480 V see fig. 6 and 13 ^b | | - | 42 | nC |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | | | - | 10 | |
| Gate-Drain Charge | Q _{gd} | | See fig. 6 and 16 | - | - | 20 | 1 |
| Turn-On Delay Time | t _{d(on)} | 1 | | - | 13 | - | |
| Rise Time | t _r | | $V_{DD} = 300 \text{ V}, I_{D} = 6.2 \text{ A}$ $R_{g} = 9.1 \Omega, R_{D} = 47 \Omega,$ | | 23 | - | |
| Turn-Off Delay Time | t _{d(off)} | $R_g =$ | | | 31 | - | ns ns |
| Fall Time | t _f | see fig. 10 ^b | | - | 18 | - | |
| Drain-Source Body Diode Characteristic | s | - | | | | | |
| Continuous Source-Drain Diode Current | Is | MOSFET symbol showing the integral reverse p - n junction diode | | ı | - | 6.2 | ^ |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 25 | A |
| Body Diode Voltage | V_{SD} | $T_J = 25$ °C, $I_S = 6.2$ A, $V_{GS} = 0$ V ^b | | - | - | 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 6.2 A, dI/dt = 100 A/µs ^b | | - | 431 | 647 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 1.8 | 2.8 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D) | | | | | [P) |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$
- c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80 % V_{DS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

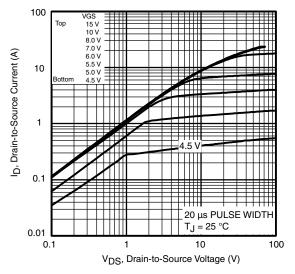


Fig. 1 - Typical Output Characteristics

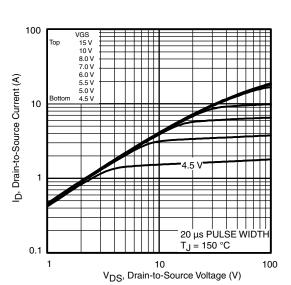


Fig. 2 - Typical Output Characteristics

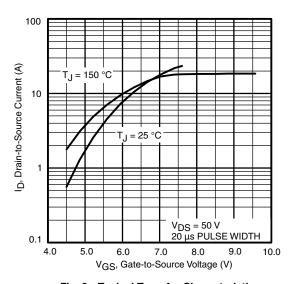


Fig. 3 - Typical Transfer Characteristics

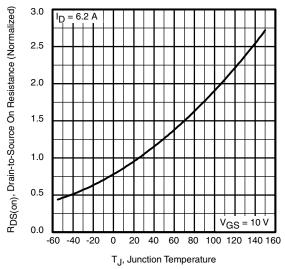


Fig. 4 - Normalized On-Resistance vs. Temperature



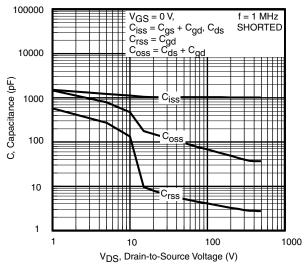


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

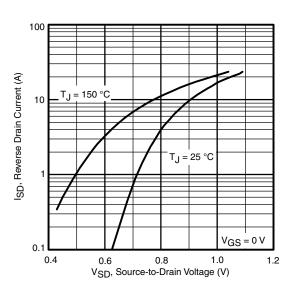


Fig. 7 - Typical Source-Drain Diode Forward Voltage

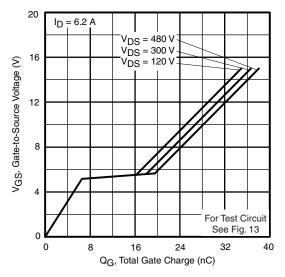


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

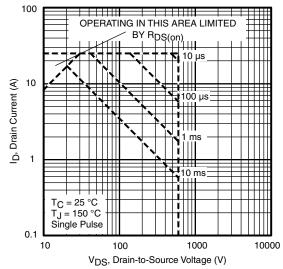


Fig. 8 - Maximum Safe Operating Area

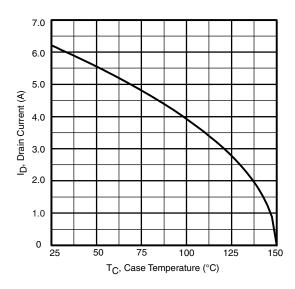


Fig. 9 - Maximum Drain Current vs. Case Temperature

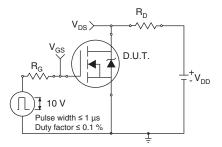


Fig. 10a - Switching Time Test Circuit

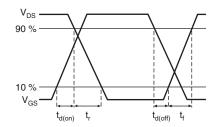


Fig. 10b - Switching Time Waveforms

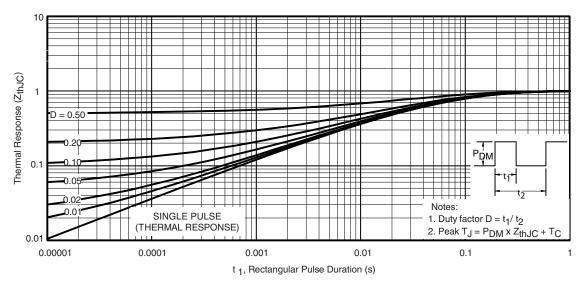


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



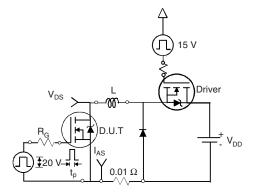


Fig. 12a - Unclamped Inductive Test Circuit

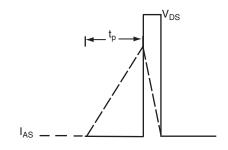


Fig. 12b - Unclamped Inductive Waveforms

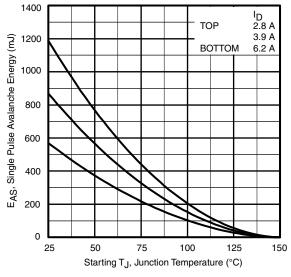


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

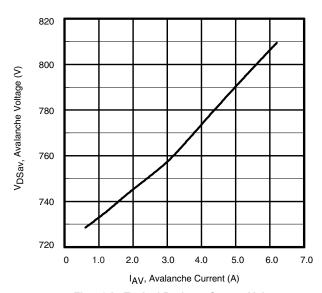


Fig. 12d - Typical Drain-to-Source Voltage vs.
Avalanche Current

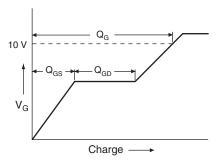


Fig. 13a - Basic Gate Charge Waveform

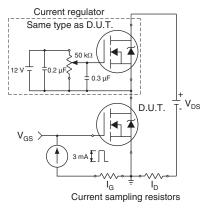
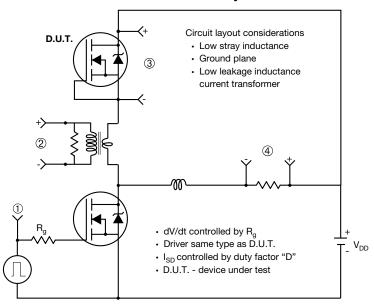


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



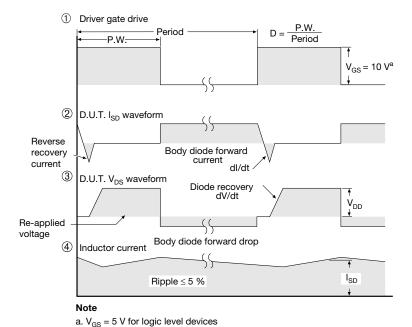


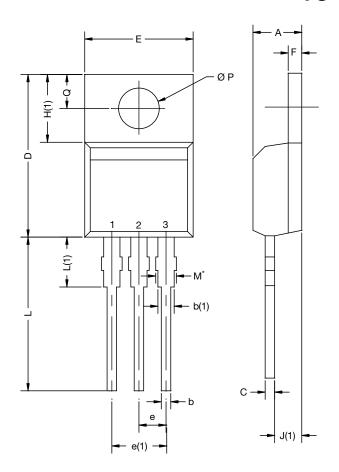
Fig. 14 - For N-Channel

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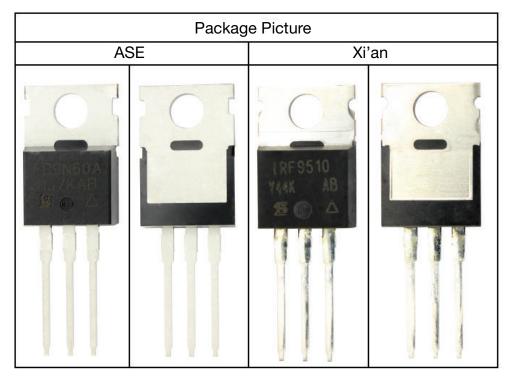
TO-220-1



| DIM. | MILLIM | IETERS | INCHES | | | |
|--|--------|--------|--------|-------|--|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | | |
| Α | 4.24 | 4.65 | 0.167 | 0.183 | | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | | |
| Е | 9.96 | 10.52 | 0.392 | 0.414 | | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | | |
| ØР | 3.53 | 3.94 | 0.139 | 0.155 | | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | | |
| ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031 | | | | | | |

Note

 M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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Revision: 02-Oct-12 Document Number: 91000

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